

**SPECIFICATION**  
**COMMERCIALY AVAILABLE**

**CERAMIC BAND PASS**  
**PART NUMBER: CF-33004005**

ISSUED / REVISION	ENGINEER APPROVED	DOCUMENT CHECKED	DRAFTSMAN	DOCUMENT CHECKED
8/16/12 DS	09/06/2012 TFG		09/06/2012 GL	
5/16/13 <sup>(kn0</sup>	06/03/2013 TFG		06/03/2013 GL	

***FILTRONETICS Inc***

1. APPLICATION

THIS SPECIFICATION APPLIES TO A BAND PASS FILTER, USING DIELECTRIC RESONATORS.

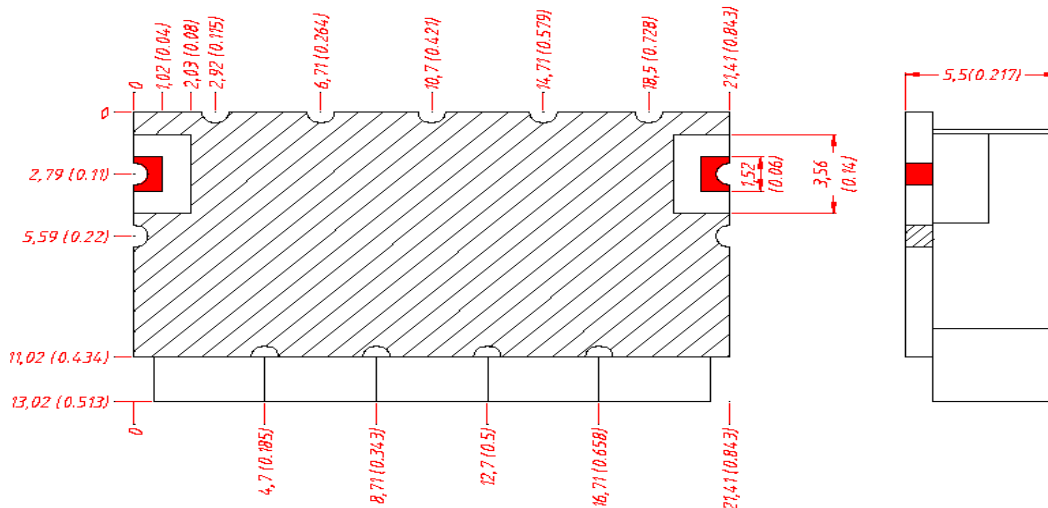
2. PART NUMBER: CF-33004005

3. SPECIFICATIONS:

No.	Parameter	Unit	Specification
1	Center Frequency	MHz	3300
2	Pass Bandwidth	MHz	$F_c \pm 200(3100 \sim 3500\text{MHz})$
3	Insertion Loss in BW	dB	2.0 max.
4	Ripple in BW	dB	1.0 max.
5	Return Loss in BW	dB	12.0 min.
6	Attenuation	dBc	30 min. @ 2700 ~ 2900MHz
			30 min. @ 3900MHz
			50 min. @ 4500 ~ 5000MHz
7	Input Power	Watt	3 max.
8	IN/OUT Impedance	$\Omega$	50
9	Operating Temp. Range	$^{\circ}\text{C}$	-40 ~ +85

4. DIMENSIONS:

Marking: CF-33004005  
 Filtronetics, Inc  
 Date Code





Bottom Side

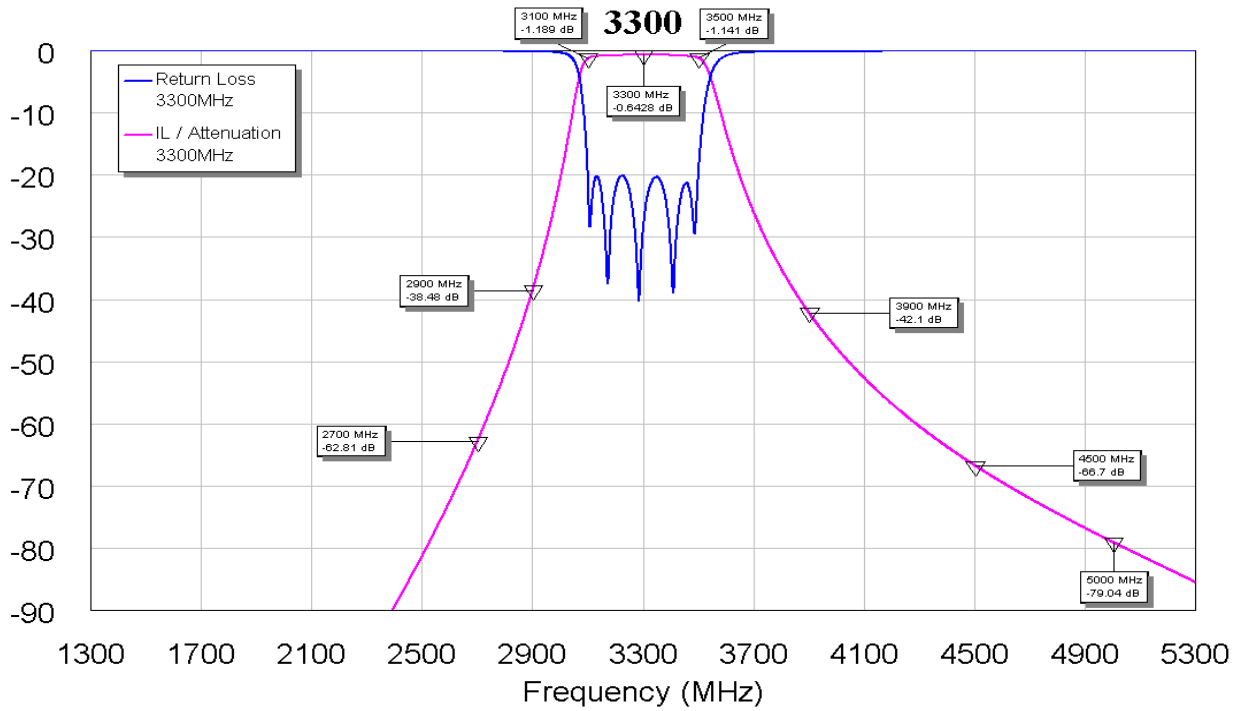
Right Side

Notes :

1. Surface mount package
2. Dimensions in millimeters
3. Max reflow temperature 230 $^{\circ}\text{C}$  for 10 sec
4. If boards are cleaned after installation units must be completely dried
5. Tolerance unless specified :  $\pm 0.3$

■ : In / Out Port  
 : Ground  
 : No metal

5. GRAPHS:



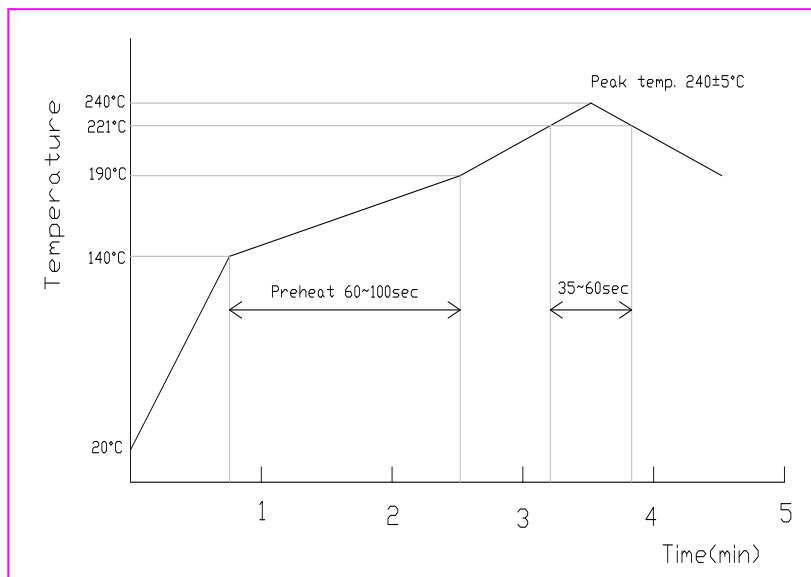
6. DEFINITIONS:

TERMS	DESCRIPTION	SPECIFICATION
Center Frequency	The midpoint of through band pass filter pass band, normally expressed as the arithmetic mean of the -3db point. Also called fo.	3. SPECIFICATION
Pass Band Width	The width of the pass band of a filter referenced to the minimum insertion loss point in the pass band. The pass band of a filter is stated as -1.0dB bandwidth.	
Insertion Loss	The loss of the filter, in db, measured at center frequency relative to a through line (0 dB).	
Attenuation	Reduction of RF power through a filter measured in dB, at desired band and referenced to 0 dB. (Filter to be removed from circuit)	
Pass Band Ripple	Variations in loss in the pass band of the filter, superimposed upon the fundamental shape of the pass band.	
V.S.W.R in Pass Band	The ratio of the maximum value of a standing wave to its minimum value, related to the return loss in pass band.	

7. RELIABILITY TEST AND CONDITIONS:

ITEM	TEST CONDITIONS	REQUIREMENTS
Resistance to solder heat	Preheat temperature : 120 to 150°C Preheat time: 1 to 1.5 min Solder temperature: 260 +/- 10°C Dipping time: 10 +/- 0.5 sec	No damage such as cracks should be caused in chip element.
Solderability	Preheat temperature: 120 to 150°C Preheat time: 1 to 1.5 min Solder temperature: 235 +/- 5°C Dipping time: 5 +/- 1 sec	More than 80% of the terminal electrode shall be covered with new solder
Heat resistance (High-temperature Load)	Temperature: 85 +/- 2°C Applied voltage: Rated voltage Applied current: Rated current Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.	No mechanical damage. After test, the device shall satisfy the specification in section 3.
Thermal shock (Temperature cycle)	Conditions for 1 cycle Step 1: + 85°C 15 min Step 2 : - 30°C 15 min Number of cycle: 10	No mechanical damage. After test, the device shall satisfy the specification in section 3.
Vibration	Frequency: 10 ~ 50 Hz Amplitude: 1.52mm ( 0.060 inches) Direction: X, Y and Z Time: each 30 min for all directions	No mechanical damage. After test, the device shall satisfy the specification in section 3.

8. REFLOW SOLDERING STANDARD CONDITIONS FOR RoHS



- Measuring point of temperature in-out terminals of the device.
- Reflow Soldering
- Both convection and infrared rays
- Hot air
- Hot plates
- Solder Cream: Sn96.5/Ag3.5